

REVISIONS					
REV.	ECN NO.	LOCATION	DESCRIPTION	DATE	DESIGN
A0	N/A		INITIAL RELEASE	/	/
A1	N/A		图面升级整理图面	2025.05.15	阿树

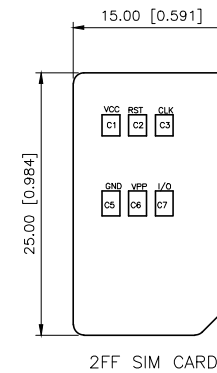
Specification

Electrical Characteristics : Current Rating:
0.5A AC/DC Max. Dielectric Withstanding
Voltage: 250V AC/DC Insulation Resistance:
500M ohms Min. Contact Resistance:
100m ohms Max. *Mechanical
Characteristics: Mating Cycles: 5000
Insertions. Environmental : Operating
Temperature:-40°C to +85°C.

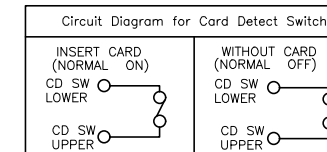
Material:
1.Housing:HI-Temp plastic UL 94V-0 Rated.
2.Contact:Copper Alloy.
3.Shell:Stainless Steel,t=0.20mm.

Plating :

Terminal:
Contact area: G/F Plated Over Nickel.
Solder area: Tin Plated Over Nickel.
Under plate: Nickel.
Shell:
Nickel Plated Over All,
Solder Area: Gold Flash.



2FF SIM CARD



PIN NO.	DESCRIPTION
P1#	C1:VCC
P2#	C5:GND
P3#	C2:RST
P4#	C6:VPP
P5#	C3:CLK
P6#	C7:I/O
P7#	CD SW LOWER
P8#	CD SW UPPER

ITEM	③ Shell	② Terminal	① Housing	PAPT	NAMF	QTY	MATERIAL	FINISHING
	1	8	1				SUS COPPER ALLOY HI-TEMP.PLASIC UL 94V-0	BLACK

AuGLAR	±5°
X.	±0.40
X.x	±0.30
X.xx	±0.20
X.xxx	±0.15
UNSPECIFIED TOLERANCES	



DESIGN	阿树	VIEW:		MODEL TYPE: SIM CARD CONN		
CHECKED		UNIT: mm/in		PART NO.: XKSIM-010		
APPROVED		SIZE: A4		DWG NO.: X-XKSIM-010		
PRECISION CO.,LIMITED				SCALE	PAGE	REVISION
				N/A	1/1	A1